

NLU2G17

Dual Non-Inverting Schmitt-Trigger Buffer

The NLU2G17 MiniGate™ is an advanced high-speed CMOS dual non-inverting Schmitt-trigger buffer in ultra-small footprint.

The NLU2G17 input and output structures provide protection when voltages up to 7.0 V are applied, regardless of the supply voltage.

The NLU2G17 can be used to enhance noise immunity or to square up slowly changing waveforms.

Features

- High Speed: $t_{PD} = 4.0 \text{ ns (Typ) @ } V_{CC} = 5.0 \text{ V}$
- Low Power Dissipation: $I_{CC} = 1 \mu\text{A (Max) at } T_A = 25^\circ\text{C}$
- Power Down Protection Provided on inputs
- Balanced Propagation Delays
- Overvoltage Tolerant (OVT) Input and Output Pins
- Ultra-Small Packages
- These are Pb-Free Devices

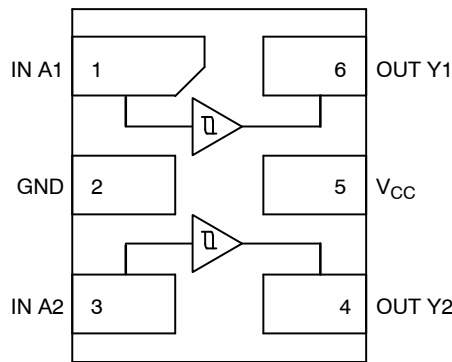


Figure 1. Pinout (Top View)

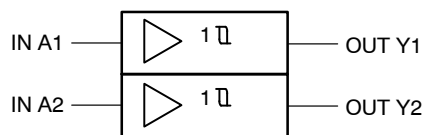


Figure 2. Logic Symbol

PIN ASSIGNMENT

| | |
|---|-----------------|
| 1 | IN A1 |
| 2 | GND |
| 3 | IN A2 |
| 4 | OUT Y2 |
| 5 | V _{CC} |
| 6 | OUT Y1 |

FUNCTION TABLE

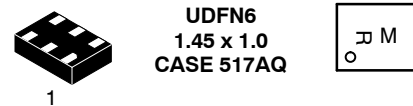
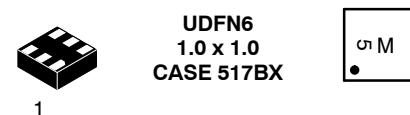
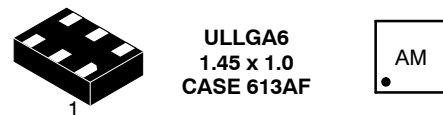
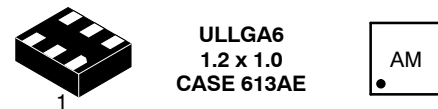
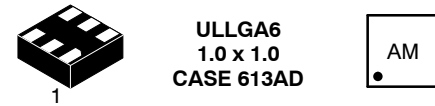
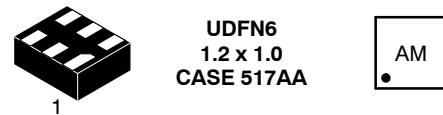
| A | Y |
|---|---|
| L | L |
| H | H |



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MARKING DIAGRAMS



M = Date Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

NLU2G17

MAXIMUM RATINGS

| Symbol | Parameter | Value | Unit |
|----------------------|---|----------------------|------|
| V _{CC} | DC Supply Voltage | -0.5 to +7.0 | V |
| V _{IN} | DC Input Voltage | -0.5 to +7.0 | V |
| V _{OUT} | DC Output Voltage | -0.5 to +7.0 | V |
| I _{IK} | DC Input Diode Current V _{IN} < GND | -20 | mA |
| I _{OK} | DC Output Diode Current V _{OUT} < GND | ±20 | mA |
| I _O | DC Output Source/Sink Current | ±12.5 | mA |
| I _{CC} | DC Supply Current Per Supply Pin | ±25 | mA |
| I _{GND} | DC Ground Current per Ground Pin | ±25 | mA |
| T _{STG} | Storage Temperature Range | -65 to +150 | °C |
| T _L | Lead Temperature, 1 mm from Case for 10 Seconds | 260 | °C |
| T _J | Junction Temperature Under Bias | 150 | °C |
| MSL | Moisture Sensitivity | Level 1 | |
| F _R | Flammability Rating Oxygen Index: 28 to 34 | UL 94 V-0 @ 0.125 in | |
| I _{LATCHUP} | Latchup Performance Above V _{CC} and Below GND at 125°C (Note 2) | ±500 | mA |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 2 ounce copper trace no air flow.
2. Tested to EIA / JESD78.

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit |
|------------------|--|--------|----------------------|------|
| V _{CC} | Positive DC Supply Voltage | 1.65 | 5.5 | V |
| V _{IN} | Digital Input Voltage | 0 | 5.5 | V |
| V _{OUT} | Output Voltage | 0 | 5.5 | V |
| T _A | Operating Free-Air Temperature | -55 | +125 | °C |
| Δt/ΔV | Input Transition Rise or Fall Rate V _{CC} = 3.3 V ± 0.3 V V _{CC} = 5.0 V ± 0.5 V | 0 0 | No Limit No Limit | ns/V |

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DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Conditions | V _{CC} (V) | T _A = 25 °C | | | T _A = +85°C | | T _A = -55°C to +125°C | | Unit |
|-----------------|-----------------------------------|--|---------------------|------------------------|------|------|------------------------|------|----------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | Min | Max | |
| V _{T+} | Positive Threshold Voltage | | 3.0 | | 2.0 | 2.2 | | 2.2 | | 2.2 | V |
| | | | 4.5 | | 3.0 | 3.15 | | 3.15 | | 3.15 | |
| | | | 5.5 | | 3.6 | 3.85 | | 3.85 | | 3.85 | |
| V _{T-} | Negative Threshold Voltage | | 3.0 | 0.9 | 1.5 | 1.65 | 0.9 | | 0.9 | | V |
| | | | 4.5 | 1.35 | 2.3 | 2.46 | 1.35 | | 1.35 | | |
| | | | 5.5 | 1.65 | 2.9 | 3.05 | 1.65 | | 1.65 | | |
| V _H | Hysteresis Voltage | | 3.0 | 0.30 | 0.57 | 1.20 | 0.30 | 1.20 | 0.30 | 1.20 | V |
| | | | 4.5 | 0.40 | 0.67 | 1.40 | 0.40 | 1.40 | 0.40 | 1.40 | |
| | | | 5.5 | 0.50 | 0.74 | 1.60 | 0.50 | 1.60 | 0.50 | 1.60 | |
| V _{OH} | Minimum High-Level Output Voltage | V _{IN} ≥ V _{T+MAX} I _{OH} = -50 μA | 2.0 | 1.9 | 2.0 | | 1.9 | | 1.9 | | V |
| | | 3.0 | 2.9 | 3.0 | | 2.9 | | 2.9 | | | |
| | | V _{IN} ≥ V _{T+MAX} I _{OH} = -4 mA | 3.0 | 2.58 | | | 2.48 | | 2.34 | | |
| | | 4.5 | 3.94 | | | 3.80 | | 3.66 | | | |
| V _{OL} | Maximum Low-Level Output Voltage | V _{IN} ≤ V _{T-MIN} I _{OL} = 50 μA | 2.0 | | 0 | 0.1 | | 0.1 | | 0.1 | V |
| | | 3.0 | | 0 | 0.1 | | 0.1 | | 0.1 | | |
| | | V _{IN} ≤ V _{T-MIN} I _{OL} = 4 mA | 3.0 | | | 0.36 | | 0.44 | | 0.52 | |
| | | 4.5 | | | 0.36 | | 0.44 | | 0.52 | | |
| I _{IN} | Input Leakage Current | 0 ≤ V _{IN} ≤ 5.5 V | 0 to 5.5 | | | ±0.1 | | ±1.0 | | ±1.0 | μA |
| I _{CC} | Quiescent Supply Current | V _{IN} = 5.5 V or GND | 5.5 | | | 1.0 | | 10 | | 40 | μA |

AC ELECTRICAL CHARACTERISTICS (Input t_r = t_f = 3.0 ns)

| Symbol | Parameter | V _{CC} (V) | Test Condition | T _A = 25 °C | | | T _A = +85°C | | T _A = -55°C to +125°C | | Unit |
|--|--|---------------------|------------------------|------------------------|-----|------|------------------------|------|----------------------------------|------|------|
| | | | | Min | Typ | Max | Min | Max | Min | Max | |
| t _{pLH} , t _{pHL} | Propagation Delay, Input A to Output \bar{Y} | 3.0 to 3.6 | C _L = 15 pF | | 7.0 | 12.8 | 1.0 | 15 | 1.0 | 17 | ns |
| | | | C _L = 50 pF | | 8.5 | 16.3 | 1.0 | 18.5 | 1.0 | 20.5 | |
| | | 4.5 to 5.5 | C _L = 15 pF | | 4.0 | 8.6 | 1.0 | 10 | 1.0 | 11.5 | |
| | | | C _L = 50 pF | | 5.5 | 10.6 | 1.0 | 12 | 1.0 | 13.5 | |
| C _{IN} | Input Capacitance | | | 5.0 | 10 | | 10 | | 10 | pF | |
| C _{PD} | Power Dissipation Capacitance (Note 3) | 5.0 | | 7.0 | | | | | | pF | |

3. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the dynamic operating current consumption without load. Average operating current can be obtained by the equation I_{CC(OPR)} = C_{PD} • V_{CC} • f_{in} + I_{CC}. C_{PD} is used to determine the no-load dynamic power consumption: P_D = C_{PD} • V_{CC}² • f_{in} + I_{CC} • V_{CC}.

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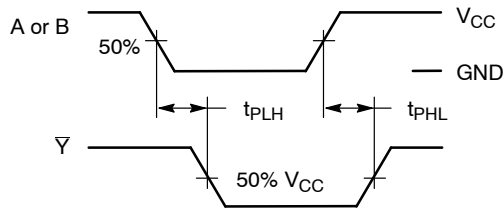
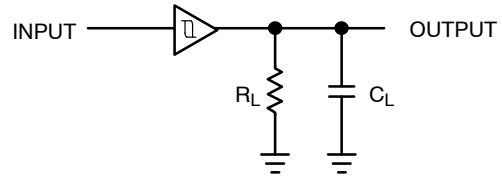
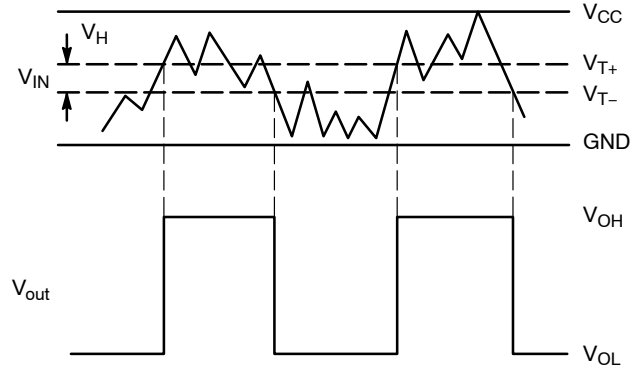
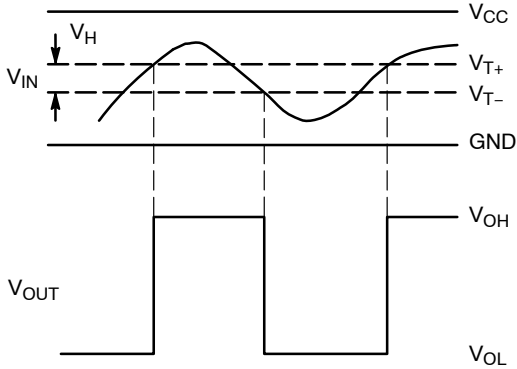


Figure 3. Switching Waveforms



A 1-MHz square input wave is recommended for propagation delay tests.

Figure 4. Test Circuit



(a) A Schmitt-Trigger Squares Up Inputs With Slow Rise and Fall Times

(b) A Schmitt-Trigger Offers Maximum Noise Immunity

Figure 5. Typical Schmitt-Trigger Applications

ORDERING INFORMATION

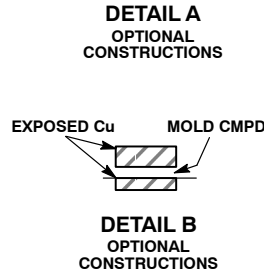
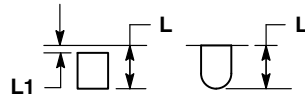
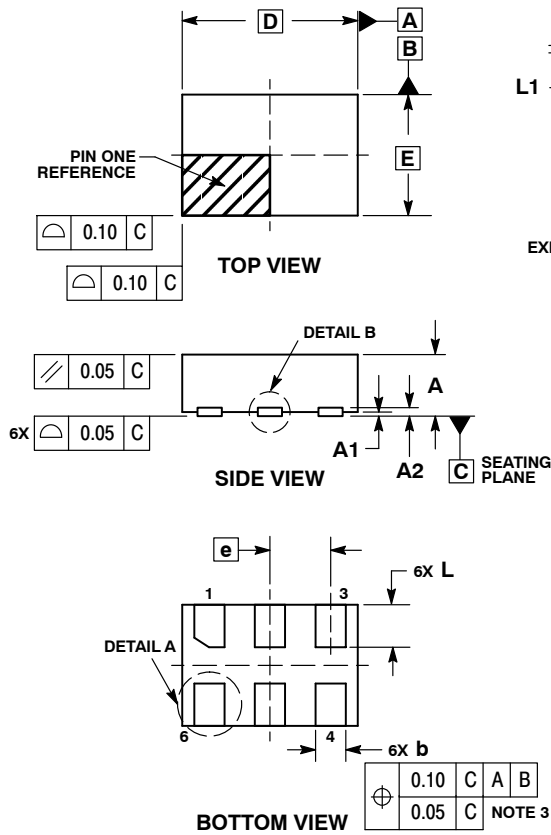
| Device | Package | Shipping† |
|----------------|---------------------------------------|--------------------|
| NLU2G17MUTCG | UDFN6, 1.2 x 1.0, 0.4P (Pb-Free) | 3000 / Tape & Reel |
| NLU2G17AMX1TCG | ULLGA6, 1.45 x 1.0, 0.5P (Pb-Free) | 3000 / Tape & Reel |
| NLU2G17BMX1TCG | ULLGA6, 1.2 x 1.0, 0.4P (Pb-Free) | 3000 / Tape & Reel |
| NLU2G17CMX1TCG | ULLGA6, 1.0 x 1.0, 0.35P (Pb-Free) | 3000 / Tape & Reel |
| NLU2G17AMUTCG | UDFN6, 1.45 x 1.0, 0.5P (Pb-Free) | 3000 / Tape & Reel |
| NLU2G17CMUTCG | UDFN6, 1.0 x 1.0, 0.35P (Pb-Free) | 3000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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PACKAGE DIMENSIONS

UDFN6 1.45x1.0, 0.5P
CASE 517AQ
ISSUE O

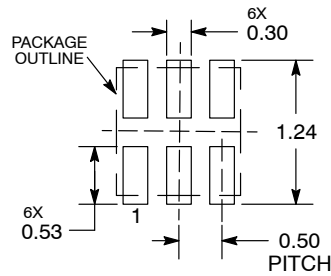


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.

| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | 0.45 | 0.55 |
| A1 | 0.00 | 0.05 |
| A2 | 0.07 REF | |
| b | 0.20 | 0.30 |
| D | 1.45 BSC | |
| E | 1.00 BSC | |
| e | 0.50 BSC | |
| L | 0.30 | 0.40 |
| L1 | --- | 0.15 |

MOUNTING FOOTPRINT



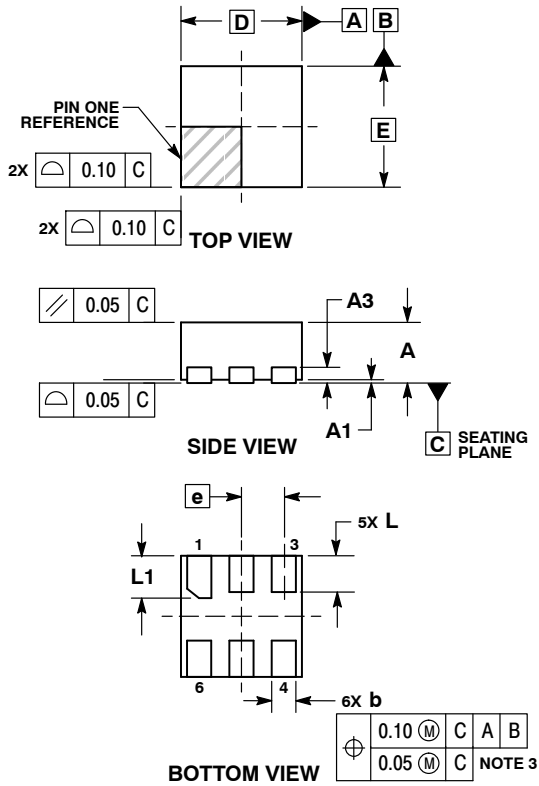
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PACKAGE DIMENSIONS

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CASE 517BX
ISSUE O

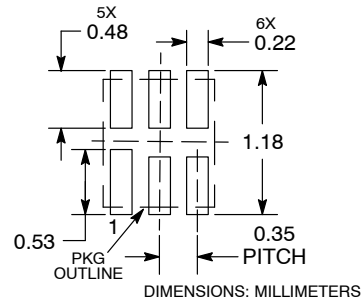


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20 MM FROM TERMINAL TIP.
4. PACKAGE DIMENSIONS EXCLUSIVE OF BURRS AND MOLD FLASH.

| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | 0.45 | 0.55 |
| A1 | 0.00 | 0.05 |
| A3 | 0.13 REF | |
| b | 0.12 | 0.22 |
| D | 1.00 BSC | |
| E | 1.00 BSC | |
| e | 0.35 BSC | |
| L | 0.25 | 0.35 |
| L1 | 0.30 | 0.40 |

RECOMMENDED SOLDERING FOOTPRINT*

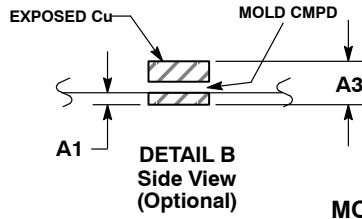
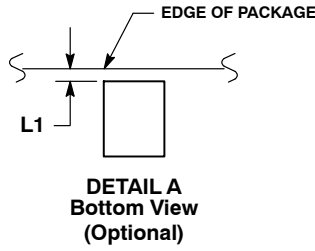
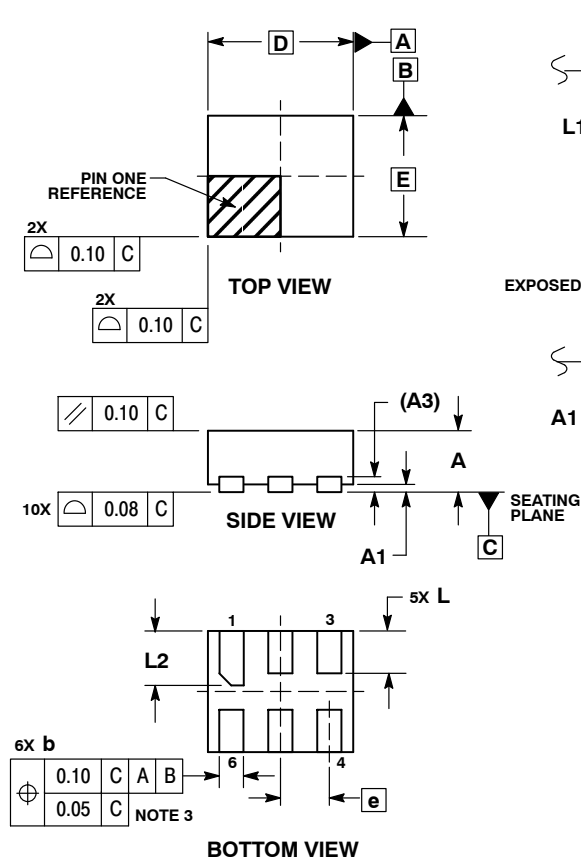


*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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PACKAGE DIMENSIONS

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CASE 517AA
ISSUE C

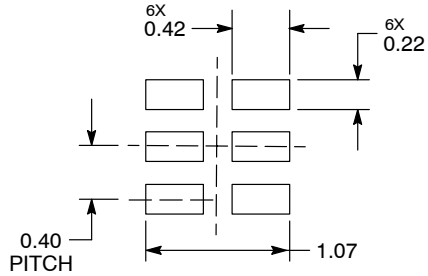


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM TERMINAL.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

| MILLIMETERS | | |
|-------------|-----------|------|
| DIM | MIN | MAX |
| A | 0.45 | 0.55 |
| A1 | 0.00 | 0.05 |
| A3 | 0.127 REF | |
| b | 0.15 | 0.25 |
| D | 1.20 BSC | |
| E | 1.00 BSC | |
| e | 0.40 BSC | |
| L | 0.30 | 0.40 |
| L1 | 0.00 | 0.15 |
| L2 | 0.40 | 0.50 |

MOUNTING FOOTPRINT*



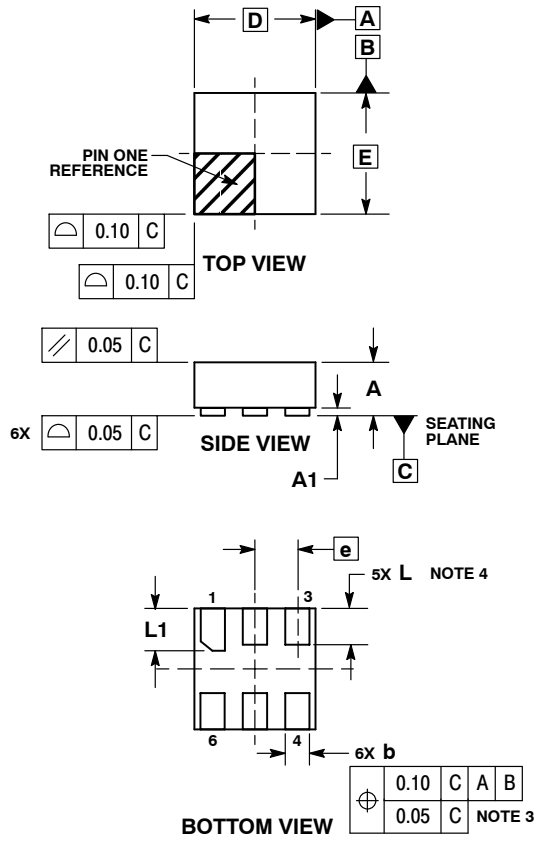
DIMENSIONS: MILLIMETERS

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PACKAGE DIMENSIONS

ULLGA6 1.0x1.0, 0.35P
CASE 613AD
ISSUE A

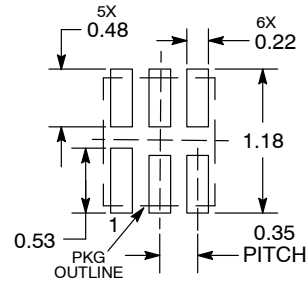


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
4. A MAXIMUM OF 0.05 mm PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | --- | 0.40 |
| A1 | 0.00 | 0.05 |
| b | 0.12 | 0.22 |
| D | 1.00 BSC | |
| E | 1.00 BSC | |
| e | 0.35 BSC | |
| L | 0.25 | 0.35 |
| L1 | 0.30 | 0.40 |

MOUNTING FOOTPRINT SOLDERMASK DEFINED*



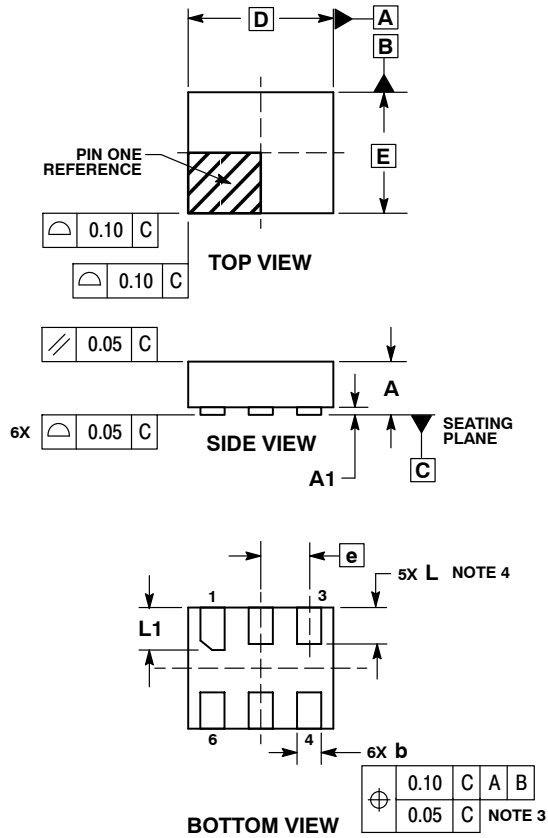
DIMENSIONS: MILLIMETERS

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PACKAGE DIMENSIONS

ULLGA6 1.2x1.0, 0.4P
CASE 613AE
ISSUE A

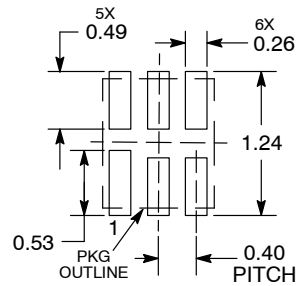


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1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
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4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | --- | 0.40 |
| A1 | 0.00 | 0.05 |
| b | 0.15 | 0.25 |
| D | 1.20 BSC | |
| E | 1.00 BSC | |
| e | 0.40 BSC | |
| L | 0.25 | 0.35 |
| L1 | 0.35 | 0.45 |

**MOUNTING FOOTPRINT
SOLDEMASK DEFINED***



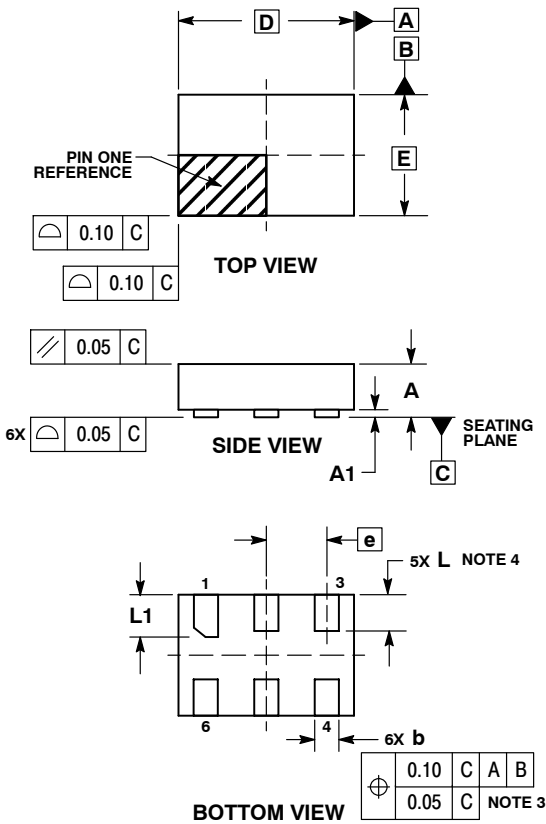
DIMENSIONS: MILLIMETERS

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PACKAGE DIMENSIONS

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CASE 613AF
ISSUE A

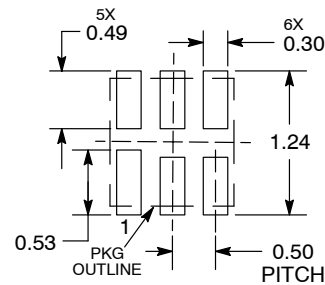


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
4. A MAXIMUM OF 0.05 PULL BACK OF THE PLATED TERMINAL FROM THE EDGE OF THE PACKAGE IS ALLOWED.

| MILLIMETERS | | |
|-------------|----------|------|
| DIM | MIN | MAX |
| A | --- | 0.40 |
| A1 | 0.00 | 0.05 |
| b | 0.15 | 0.25 |
| D | 1.45 BSC | |
| E | 1.00 BSC | |
| e | 0.50 BSC | |
| L | 0.25 | 0.35 |
| L1 | 0.30 | 0.40 |

MOUNTING FOOTPRINT SOLDERMASK DEFINED*



DIMENSIONS: MILLIMETERS

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